



DIM.	MIN.	TYP.	MAX.
* A	7.90		8.50
* B	5.00		5.60
C	1.67		2.00
E	7.40		8.20
F		7.15	
H	0.05		0.21
J	0.22		0.38
L	0.55		0.95
P		0.65	
T	0.09		0.25
X	0°		8°
Y	7°		9°
Z	4°		12°

NOTE :

* A & B are reference data and do not include mold deflash or protrusions.

All dimensions in mm

Angles are in degrees

Co-Planarity of leads within 0.1mm



CML Microcircuits

COMMUNICATION SEMICONDUCTORS

TITLE		DRAWING No. D5	
24-pin SSOP Package		D'WN	S.D.F.
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